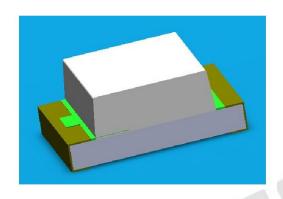


DATASHEET

SMD B

17-215-G6C-F5M1N2B0E-3T-AM



Features

- RoHS compliant
- •Chip LED package.
- •Colorless clear resin.
- •Wide viewing angle 130 °
- •Brightness:18.0 to 45.0 mcd at 20mA.
- •Qualification according to AEC-Q101.
- •Precondition: Bases on JEDEC J-STD 020 Level 3.
- •Automotive reflow profile (IR reflow or wave soldering)
- Compliance with EU REACH
- •Compliance Halogen Free .(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm).

Applications

2

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- •Automotive backlighting or indicator: Dashboard, switch, audio and video equipments...etc.
- •Backlight: LCD, switches, symbol, mobile phone and illuminated advertising.
- •Display for indoor and outdoor application.
- •Ideal for coupling into light guides.
- •Substitution of traditional light.
- Optical indicator.
- •General applications.

Device Selection Guide

Chip Materials	Emitted Color	Resin Color
AlGalnP	Brilliant Yellow Green	Water Clear

Absolute Maximum Ratings (Ta=25)

Parameter	Symbol	Rating	Unit
Reverse Voltage	V _R	12	V
Forward Current	I _F	25	mA
Peak Forward Current (Duty 1/10 @1KHz)	I _{FP}	60	mA
Power Dissipation	Pd	60	mW
Junction Temperature	T_j	115	
Operating Temperature	T_{opr}	-40 ~ +100	
Storage Temperature	Tstg	-40 ~ +110	
Thormal Decistores	Rth _{J-A}	800	K/W
Thermal Resistance	Rth _{J-S}	450	K/W
ESD	ESD _{HBM}	2000	V
(Classification acc. AEC Q101)	ESD _{MM}	200	V
Soldering Temperature	T _{sol}	Reflow Soldering : 2 Hand Soldering : 35	

Electro-Optical Characteristics (Ta=25)

R 2

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Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	lv	18.0		45.0	mcd	
Viewing Angle	2θ _{1/2}		130		deg	
Peak Wavelength	λр		575		nm	I =20 A
Dominant Wavelength	λd	568		574	nm	I _F =20mA
Spectrum Radiation Bandwidth	Δλ		20		nm	
Forward Voltage	V_{F}	1.75		2.35	V	
Reverse Current	I _R			10	μΑ	V _R =12V
Temperature coefficient of λp	TC_{\lambdap}		0.13		nm/K	
Temperature coefficient of λd	TC_{\lambdad}		0.08		nm/K	I _F =20mA
Temperature coefficient of V _F	TC_V		-4.3		mV/K	

Note:

- 1. Tolerance of Luminous Intensity: ±11%
- 2. Tolerance of Dominant Wavelength: ±1nm
- 3. Tolerance of Forward Voltage: ±0.1V

Bin Range of Luminous Intensity

Bin Code	Min.	Max.	Unit	Condition
M1	18.0	22.4		
M2	22.4	28.0		
N1	28.0	35.5	mcd	I _F =20mA
N2	35.5	45.0		

Note:

Tolerance of Luminous Intensity: ±11%

Bin Range of Dominant Wavelength

Bin Code	Min.	Max.	Unit	Condition
1	568	571		
2	571	574	— nm	I _F =20mA

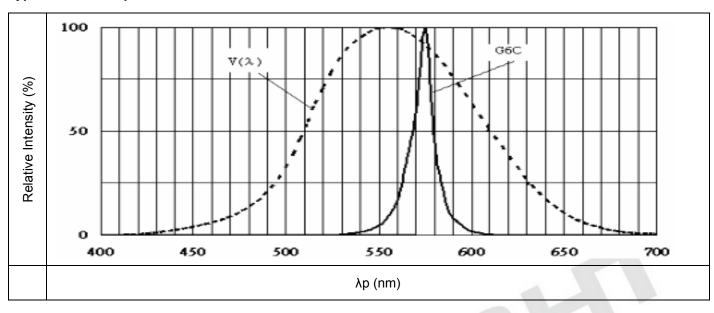
Note:

Tolerance of Dominant Wavelength: ±1nm



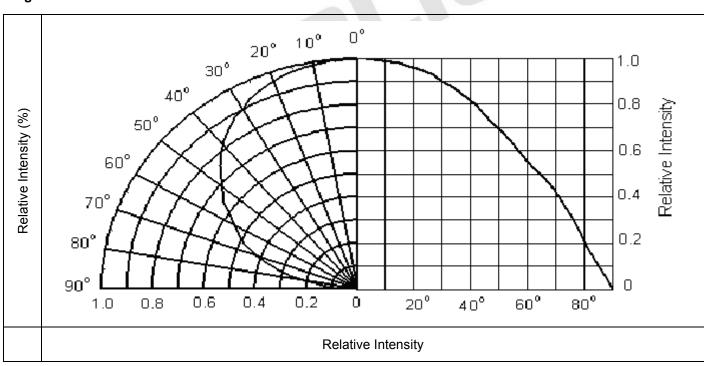
Typical Electro-Optical Characteristics Curves

Typical Curve of Spectral Distribution

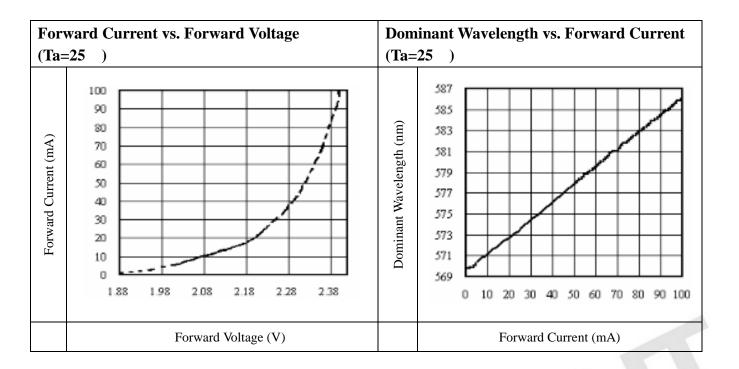


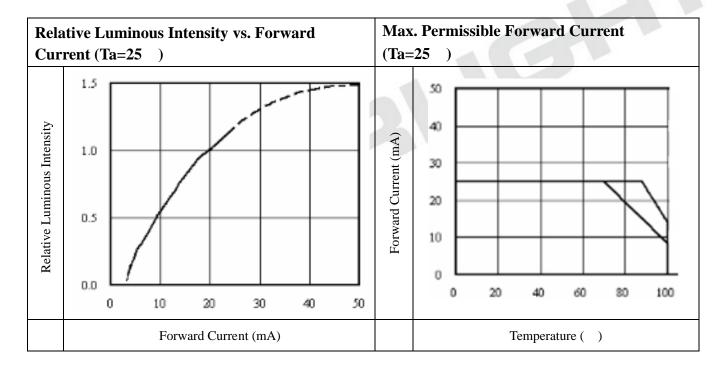
Note: $V(\lambda)$ =Standard eye response curve; I_F =20mA

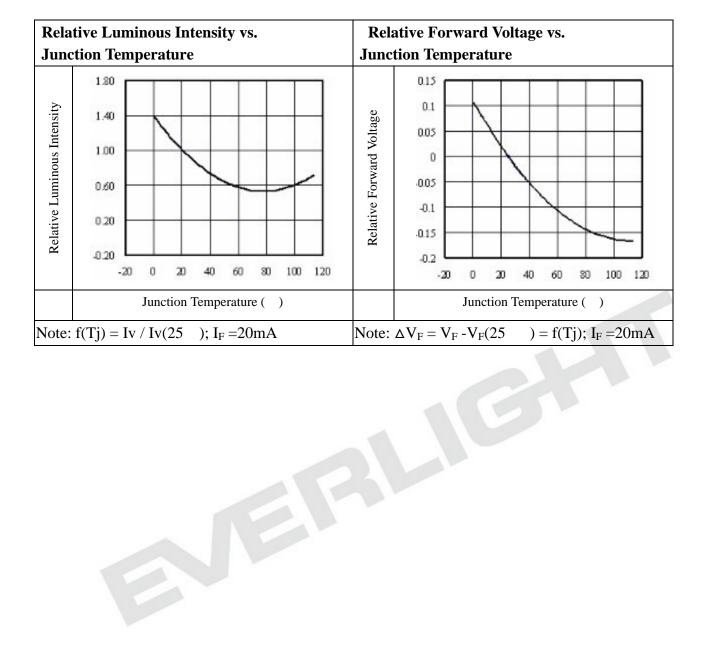
Diagram Characteristics of Radiation





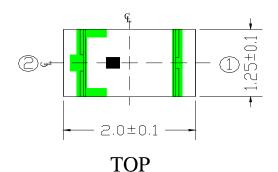


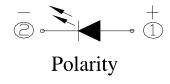


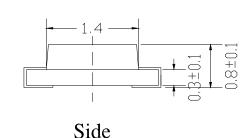




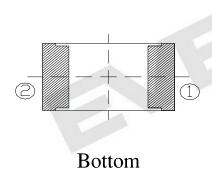
Package Dimension

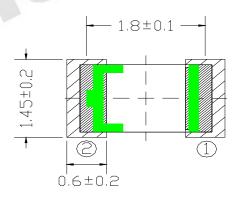






Recommend Sodering Pad





Suggested pad dimension is just for reference only. Please modify the pad dimension based on individual need.

Note: Tolerances unless mentioned ±0.1mm. Unit = mm



Moisture Resistant Packing Materials

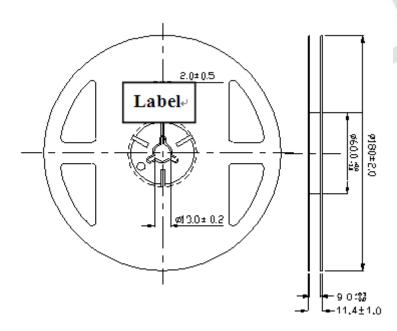
Label Explanation



Label Explanation

- CPN: Customer's Product Number
- P/N: Product Number
- QTY: Packing Quantity
- CAT: Luminous Intensity Rank
- HUE: Dom. Wavelength Rank
- REF: Forward Voltage Rank
- LOT No: Lot Number

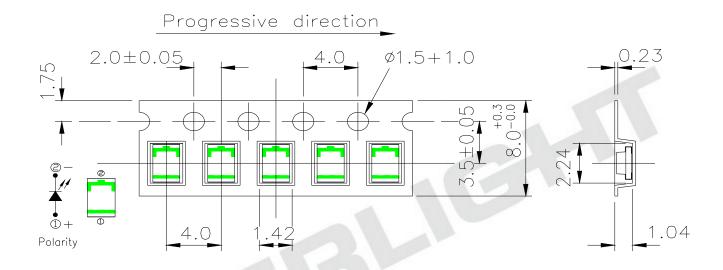
Reel Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

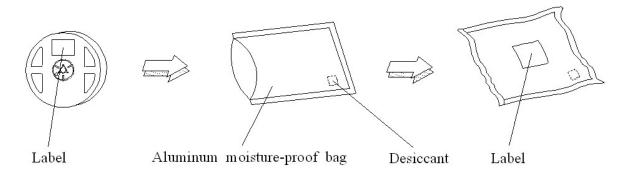


Carrier Tape Dimensions: Loaded Quantity 3000 pcs Per Reel



Note: Tolerances unless mentioned ±0.1mm. Unit = mm

Moisture Resistant Packing Process



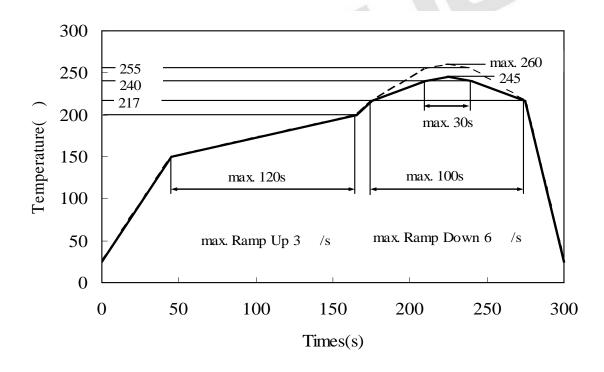


Note: Tolerances unless mentioned ±0.1mm. Unit = mm

Precautions for Use

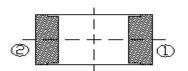
1. Soldering Condition (Reference: IPC/JEDEC J-STD-020D)

a. IR reflow

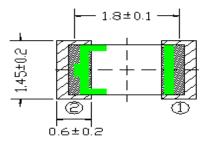




(B) Recommend soldering pad



Recommend Sodering Pad



Note: Tolerances unless mentioned ± 0.1 mm. Unit = mm

2. Current limiting

A resistor should be used to limit current spikes that can be caused by voltage fluctuations. Otherwise damage could occur.

3. Storage

- 3.1 Moisture proof bag should only be opened immediately prior to usage.
- 3.2 Environment should be less than 30 and 60% RH when moisture proof bag is opened.
- 3.3 After opening the package MSL Conditions stated on page 1 of this spec should not be exceeded.
- 3.4 If the moisture sensitivity card indicates higher than acceptable moisture, the component should be baked at min. 60deg +/-5deg for 24 hours.

4. Iron Soldering

Hand soldering is not recommended for regular production. These guidelines are for rework only. Soldering iron tip should contact each terminal no more than 3 sec at 350 , using soldering iron with nominal power



less than 25W. Allow min. 2 sec. between soldering intervals.

5. Usage

Do not exceed the values given in this specification.

Application Restrictions

1. High reliability applications such as military/aerospace, automotive safety/security systems, and medical equipment may require different product. If you have any concerns, please contact Everlight before using this product in your application. This specification guarantees the quality and performance of the product as an individual component. Do not use this product beyond the specification described in this document.

Revision History:

Revision	History:	
Rev.	Modified date	File modified contents
1	2008/8/16	New Spec
2	2014/9/9	Release